

## NC7SZD384

# 1-Bit Low Power Bus Switch with Level Shifting

#### **General Description**

The NC7SZD384 provides 1-bit of high-speed CMOS TTL-compatible bus switch. The low on resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a bus enable  $\overline{(OE)}$  signal. When  $\overline{OE}$  is LOW, the switch is on and Port A is connected to Port B. When  $\overline{OE}$  is HIGH, the switch is open and a high-impedance state exists between the two ports. Reduced voltage drive to the gate of the FET switch permits nominal level shifting of 5V to 3.3V through the switch.

#### **Features**

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ Pb-Free leadless package
- $\blacksquare$  5 $\Omega$  switch connection between two ports
- Designed to be used in level-shifting applications
- Minimal propagation delay through the switch
- Low I<sub>CC</sub>
- Zero bounce in flow-through mode
- Control inputs compatible with TTL level

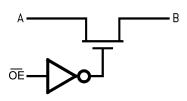
#### **Ordering Code:**

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZD384M5X	MA05B	8Z4D	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7SZD384P5X	MAA05A	Z4D	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7SZD384L6X	MAC06A	A4	Pb-Free 6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

# **Logic Symbol**



## **Pin Descriptions**

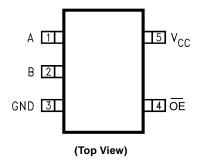
Pin Name	Description
OE	Bus Switch Enable
Α	Bus A
В	Bus B
NC	No Connect

### **Function Table**

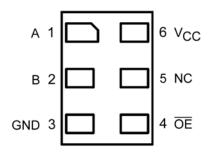
OE	B <sub>O</sub>	Function
L	A <sub>O</sub>	Connect
Н	HIGH-Z State	Disconnect

## **Connection Diagrams**

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Through View)

## **Absolute Maximum Ratings**(Note 1)

Supply Voltage (V <sub>CC</sub> )	-0.5V to $+7.0V$
DC Switch Voltage (VS)	-0.5V to $+7.0V$
DC Input Voltage (V <sub>IN</sub> ) (Note 2)	-0.5V to $+7.0V$
DC Input Diode Current ( $I_{IK}$ ) $V_{IN} < 0V$	-50 mA
DC Output (I <sub>OUT</sub> ) Sink Current	128 mA
DC V <sub>CC</sub> /GND Current (I <sub>CC</sub> /GND)	±100 mA
Storage Temperature Range (T <sub>STG</sub> )	-65°C to +150°C
Junction Temperature under bias (T <sub>J</sub> )	+150°C
Junction Lead Temperature (T <sub>L</sub> )	
(Soldering, 10 seconds)	+260°C
Power Dissipation (P <sub>D</sub> ) @ +85°C	
SOT23-5	200 mW
SC70-5	150 mW

# Recommended Operating Conditions (Note 3)

Power Supply Operating (V <sub>CC</sub> )	4.5V to 5.5V
Input Voltage (V <sub>IN</sub> )	0V to 5.5V
Output Voltage (V <sub>OUT</sub> )	0V to 5.5V
Input Rise and Fall Time (t <sub>r</sub> , t <sub>f</sub> )	
Switch Control Input	0 ns/V to 5 ns
Switch I/O	0 ns/V to DC
Operating Temperature (T <sub>A</sub> )	-40°C to +85°C
Thermal Resistance ( $\theta_{JA}$ )	
SOT23-5	300°C/Watt
SC70-5	425°C/Watt

**Note 1:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:** The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

#### **DC Electrical Characteristics**

		V <sub>CC</sub>	T,	<sub>A</sub> = -40°C to +85°	°C	Units		
Symbol	Parameter	(V)	Min	Typ (Note 4)			Conditions	
V <sub>IK</sub>	Maximum Clamp Diode Voltage	4.5			-1.2	-V	I <sub>IN</sub> = -18 mA	
V <sub>IH</sub>	HIGH Level Input Voltage	4.5-5.5	2.0			V		
V <sub>IL</sub>	LOW Level Input Voltage	4.5-5.5			8.0	V		
V <sub>OH</sub>	HIGH Level Output Voltage	4.5-5.5		See Figure 3		V	$V_{IN} = V_{CC}$	
I <sub>I</sub>	Input Leakage Current	0–5.5			±1.0	μΑ	$0 \le V_{IN} \le 5.5V$	
I <sub>OFF</sub>	"OFF" Leakage Current	5.5			±10.0	μΑ	0 ≤ A, B, ≤ V <sub>CC</sub>	
R <sub>ON</sub>	Switch On Resistance (Note 5)	4.5		5.0	7.0	Ω	V <sub>IN</sub> = 0V, I <sub>I</sub> = 64 mA	
				5.0	7.0	Ω	$V_{IN} = 0V, I_{I} = 30 \text{ mA}$	
				35.0	50.0	Ω	V <sub>IN</sub> = 2.4V, I <sub>I</sub> = 15 mA	
I <sub>CC</sub>	Quiescent Supply Current						$V_{IN} = V_{CC}$ or GND, $I_O = 0$	
	Switch On	5.5		0.8	1.5	mA	OE = GND	
	Switch Off	5.5			10.0	μΑ	OE = V <sub>CC</sub>	
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input (Note 6)	5.5		0.8	2.5	mA	OE = 3.4V, I <sub>O</sub> = 0,	
							Control Input only.	

Note 4: All typical values are at  $V_{CC}=5.0V,\,T_{A}\!\!=25^{\circ}C.$ 

Note 5: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 6: Per TTL driven input ( $V_{IN} = 3.4V$ , control input only). A and B pins do not contribute to  $I_{CC}$ .

#### **AC Electrical Characteristics**

Symbol	Parameter	V <sub>cc</sub>	$T_A = -40$ °C to $+85$ °C $C_L = 50$ pF, RU = RD = $500\Omega$			Units	Conditions	Figure
		(V)	Min	Typ (Note 7)	Max	=		Number
t <sub>PHL</sub> ,	Propagation Delay Bus-to-Bus	4.5–5.5			0.25	ns	V <sub>I</sub> = OPEN	Figures
t <sub>PLH</sub>	(Note 8)							1, 2
t <sub>PZL</sub> ,	Output Enable Time	4.5–5.5	1.5		7.5	ns	V <sub>I</sub> = 7V for t <sub>PZL</sub>	Figures
$t_{PZH}$							$V_I = OPEN$ for $t_{PZH}$	1, 2
$t_{PLZ}$ ,	Output Disable Time	4.5–5.5	1.0		6.0	ns	$V_I = 7V$ for $t_{PLZ}$	Figures
$t_{PHZ}$							$V_I = OPEN \text{ for } t_{PHZ}$	1, 2

Note 7: All typical values are  $V_{CC}=5.0V,\,T_A=25\,^{\circ}C.$ 

Note 8: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

#### Capacitance (Note 9)

Symbol	Parameter	Тур	Max	Units	Conditions
C <sub>IN</sub>	Control Pin Input Capacitance	2	5	pF	V <sub>CC</sub> = 5.0V
C <sub>I/O</sub>	Input/Output Capacitance	4.5	10	pF	V <sub>CC</sub> = 5.0V

Note 9:  $T_A = 25^{\circ}C$  f = 1MHz

## **AC Loading and Waveforms**

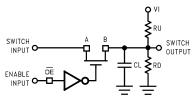
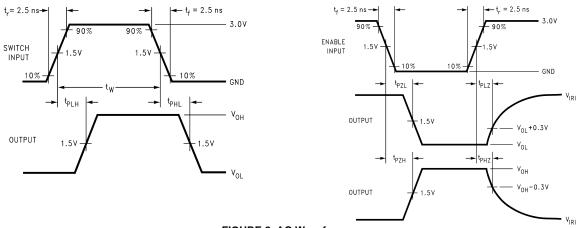


FIGURE 1. AC Test Circuit

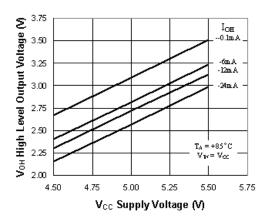
Note: Input driven by  $50\Omega$  source terminated in  $50\Omega$ .

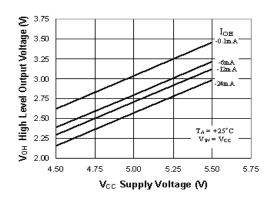
C<sub>L</sub> includes load and stray capacitance.

Input PRR =  $1.0 \text{ MHz } t_w = 500 \text{ ns.}$ 



#### **DC Characteristics**





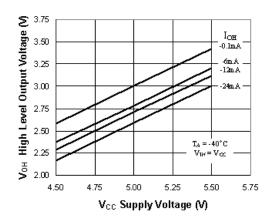


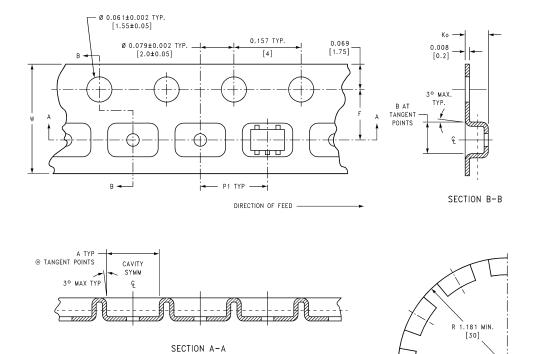
FIGURE 3. Typical High Level Output Voltage vs. Supply Voltage

## **Tape and Reel Specification**

#### TAPE FORMAT for SC70 and SOT23

Package	Tape	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
M5X, P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

#### TAPE DIMENSIONS inches (millimeters)

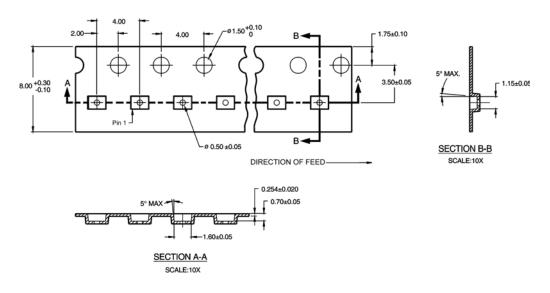


Package	Tape Size	DIM A	DIM B	DIM F	DIM K <sub>o</sub>	DIM P1	DIM W
0070 F	)-5 8 mm	0.093	0.096	$0.138 \pm 0.004$	$0.053 \pm 0.004$	0.157	$0.315 \pm 0.004$
SC70-5		(2.35)	(2.45)	$(3.5 \pm 0.10)$	(1.35 ± 0.10)	(4)	(8 ± 0.1)
COTOO F	0	0.130	0.130	$0.138 \pm 0.002$	$0.055 \pm 0.004$	0.157	$0.315 \pm 0.012$
SOT23-5	8 mm	(3.3)	(3.3)	$(3.5 \pm 0.05)$	$(1.4 \pm 0.11)$	(4)	$(8 \pm 0.3)$

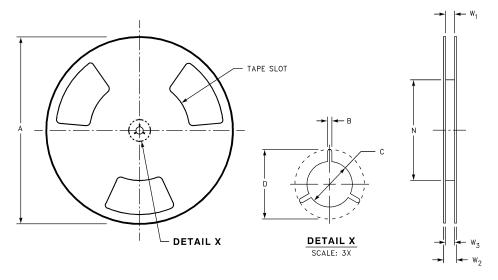
BEND RADIUS NOT TO SCALE

**TAPE FORMAT for MicroPak** 

Package	Package Tape		Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

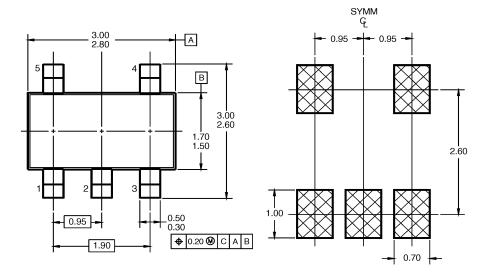


#### **REEL DIMENSIONS** inches (millimeters)

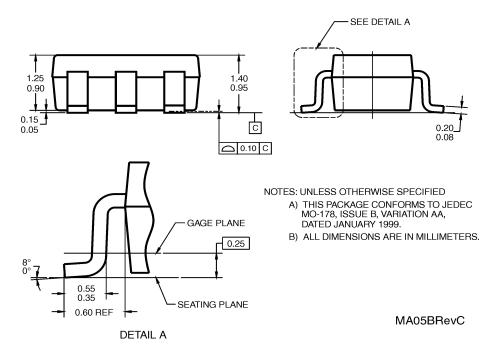


Tape Size	Α	В	С	D	N	W1	W2	W3
0 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
8 mm	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

## Physical Dimensions inches (millimeters) unless otherwise noted

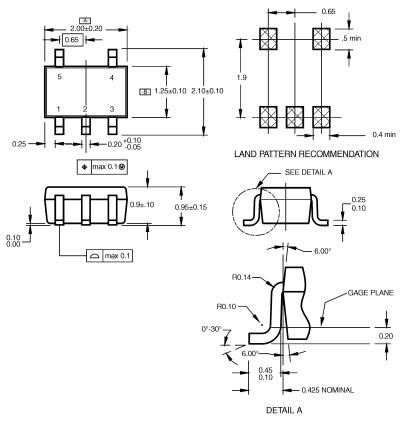


#### LAND PATTERN RECOMMENDATION



5-Lead SOT23, JEDEC MO-178, 1.6mm Package Number MA05B

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



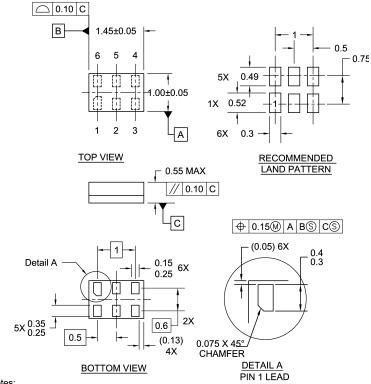
#### NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

Pb-Free 6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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ZL50016GAG2 TC7MBL3257CFT(EL) PI3CH800QE MT90823AB1 ZL50075GAG2 PI5C32X245BEX PI5C3126QEX PI5C3125QEX PI3VT3245-AQE PI3CH800QEX PI3C3384QE PI3C3305UEX PI3B3861QEX PI3B3861QE PI3B32X245BEX PI3B3245QEX PI3B3245QE PI3CH800ZHEX PI3CH1000LE PI3CH400ZBEX 728981JG8 TC7MBL3257CFK(EL) 728985JG8 PI3CH401LE PI3CH401LEX FST3126DR2G QS34X245Q3G8 QS3VH125S1G8 TC7WBL3305CFK(5L,F 74CB3Q3125DBQRE4 74FST6800PGG8 74CB3Q3244DBQRE4 74CBTLV3125PGG8 TC7MBL3125CFT(EL)